

450V N-Channel MOSFET

General Features

- Proprietary New Planar Technology
- R_{DS(ON),typ}=0.48 Ω@V_{GS}=10V
- Low Gate Charge Minimize Switching Loss
- Fast Recovery Body Diode

Applications

- Ballast and Lighting
- DC-AC Inverter
- Other Applications

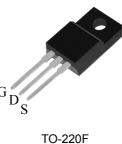
Ordering Information

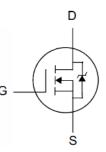
Part Number	Package	Brand
PTA09N45	TO-220F	ž

Absolute Maximum Ratings



BV _{DSS}	R _{DS(ON),typ.}	I _D
450V	0.48Ω	9A





Package No to Scale

 $T_C \mbox{=} 25\,^\circ \mbox{C}$ unless otherwise specified

Symbol	Parameter	PTA09N45	Unit
V _{DSS}	Drain-to-Source Voltage ^[1]	450	v
V _{GSS}	Gate-to-Source Voltage	±30	
I _D	Continuous Drain Current	9	
I _{D @ Tc =100} ℃	Continuous Drain Current @ Tc=100℃	Figure 3	A
I _{DM}	Pulsed Drain Current at V _{GS} =10V ^[2]	Figure 6	
E _{AS}	Single Pulse Avalanche Energy	500	mJ
dv/dt	Peak Diode Recovery dv/dt ^[3]	5.0	V/ns
Р	Power Dissipation	40	W
P _D	Derating Factor above 25°C	0.32	W/°C
T _L T _{PAK}	Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10 seconds, Package Body for 10 seconds	300 260	°C
T _J & T _{STG}	Operating and Storage Temperature Range	-55 to 150	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

Thermal Characteristics

Symbol	Parameter	PTA09N45	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case	3.125	
R _{θJA}	Thermal Resistance, Junction-to-Ambient	100	°C <i>I</i> W

Electrical Characteristics

OFF Characteristics $T_J = 25^{\circ}C$ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	450			V	V_{GS} =0V, I _D =250uA
	I _{DSS} Drain-to-Source Leakage Current			1		V_{DS} =450V, V_{GS} =0V
I _{DSS}				100	uA	V _{DS} =360V, V _{GS} =0V, T _J =125℃
	$Gate-to-Source Leakage Current \qquad \qquad +100 \\ \qquad \qquad -100 $	54	V_{GS} =+30V, V_{DS} =0V			
I _{GSS}				-100	ПА	V _{GS} =-30V, V _{DS} =0V

ON Characteristics

ON Characteristics				T_J =25 $^\circ\!\!\!\!\!\!^\circ$ unless otherwise specified		
Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
R _{DS(ON)}	Static Drain-to-Source On-Resistance ^[4]		0.48	0.65	Ω	V _{GS} =10V, I _D =4.5A
$V_{GS(TH)}$	Gate Threshold Voltage	2.0		4.0	V	V_{DS} = V_{GS} , I_D =250uA
gfs	Forward Transconductance ^[4]		12		S	VDS=20V,ID=9A

Dynamic Characteristics

Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
C _{iss}	Input Capacitance		1120		pF	V _{GS} =0V, V _{DS} =25V, f=1.0MH _Z
C _{rss}	Reverse Transfer Capacitance		11			
C _{oss}	Output Capacitance		92			
Q _g	Total Gate Charge		20			
Q _{gs}	Gate-to-Source Charge		5		nC	V_{DD} =225V, I _D =9A, V _{GS} =0 to 10V
Q _{gd}	Gate-to-Drain (Miller) Charge		5			

Resistive Switching Characteristics

Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
td(ON)	Turn-on Delay Time		11			
trise	Rise Time		10		- ns	V _{DD} =225V, I _D =9A, V _{GS} =10V Rg=4.7Ω
td(OFF)	Turn-Off Delay Time		18			
tfall	Fall Time		10			

Source-Drain Body Diode Characteristics

 $T_J {=} 25\,^\circ\!\mathrm{C}$ unless otherwise specified

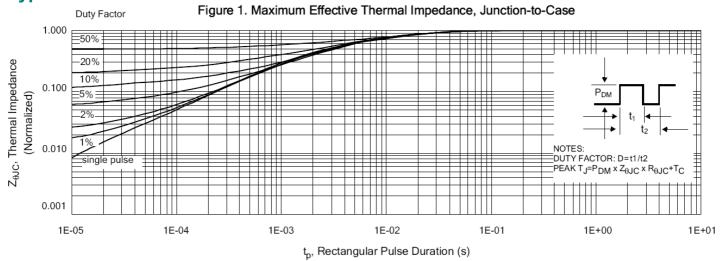
Symbol	Parameter	Min	Тур.	Max.	Unit	Test Conditions
I _{SD}	Continuous Source Current ^[4]			9	А	Integral PN-diode in MOSFET
I _{SM}	Pulsed Source Current ^[4]			36		
V_{SD}	Diode Forward Voltage			1.5	V	I _S =9A, V _{GS} =0V
trr	Reverse recovery time		300		ns	V _{GS} =0V ,I _F =9A,
Qrr	Reverse recovery charge		1.0		uC	di⊧/dt=100A/µs

Note:

[1] T_J=+25℃ to +150℃

- [2] Repetitive rating; pulse width limited by maximum junction temperature. [3] IsD= 10A di/dt < 100 A/ μ s, VDD < BVDss, TJ=+150 °C.
- [4] Pulse width≤380µs; duty cycle≤2%.

Typical Characteristics



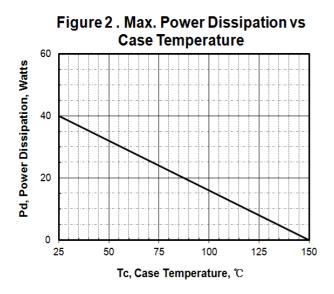


Figure 4. Typical Output Characteristics

10

V_{DS}, Drain-to-Source Voltage (V)

VGS

 $V_{GS} = 7.0V$

V_{GS} = 6.5V

 $V_{GS} = 6.0V$

 $V_{GS} = 5.5V$

 $V_{GS} = 5.0V$

20

15

PULSE DURATION = 250 µS

DUTY FACTOR = 0.5% MAX

5

 $T_C = 25 °C$

25

20

15

10

5

0

0

I_D, Drain Current (A)

Figure 3 .Maximum Continuous Drain

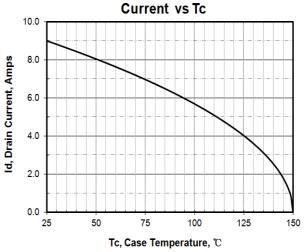
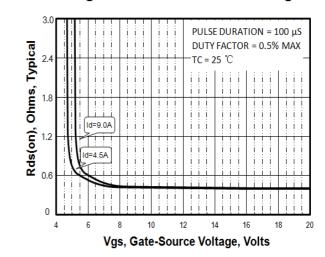
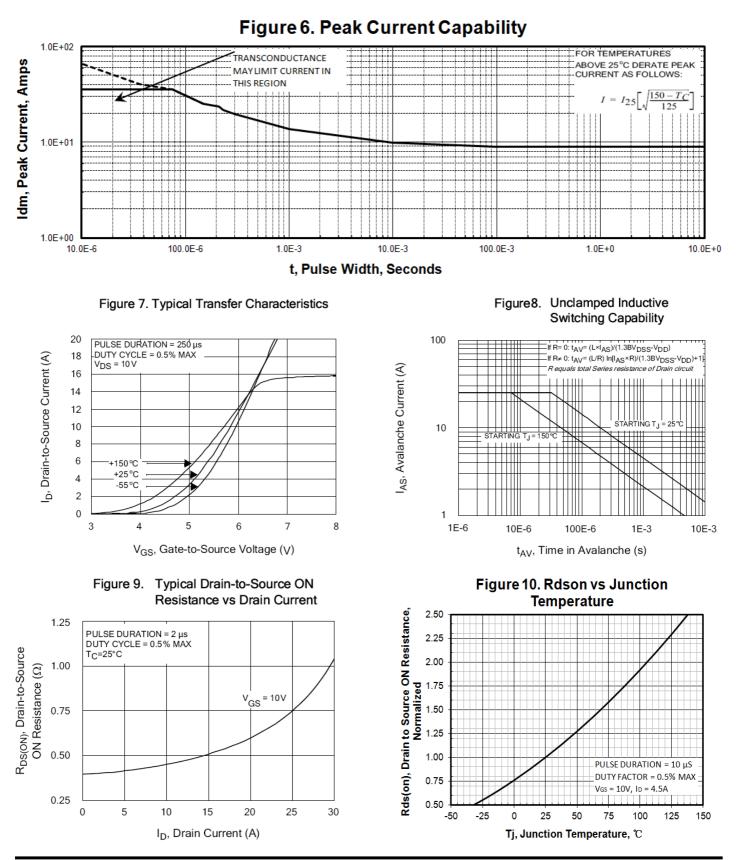


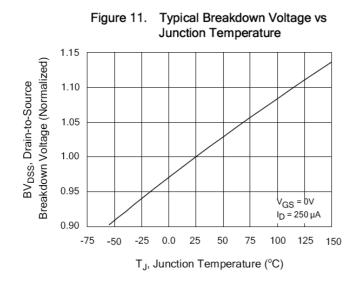
Figure 5. Rdson vs Gate Voltage

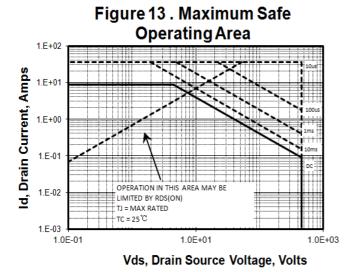


Typical Characteristics(Cont.)

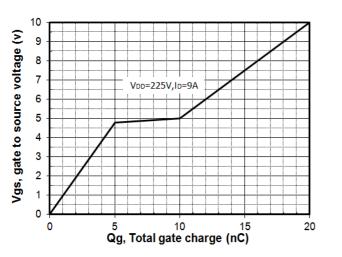


Typical Characteristics(Cont.)









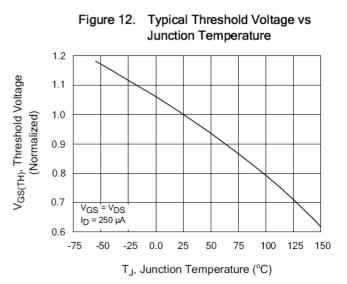


Figure 14. Typical Capacitance vs Drain-to-Source Voltage

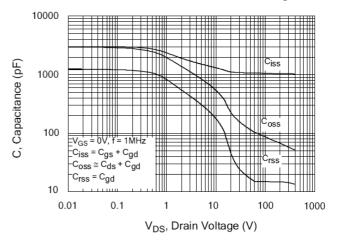
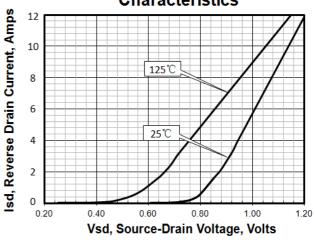
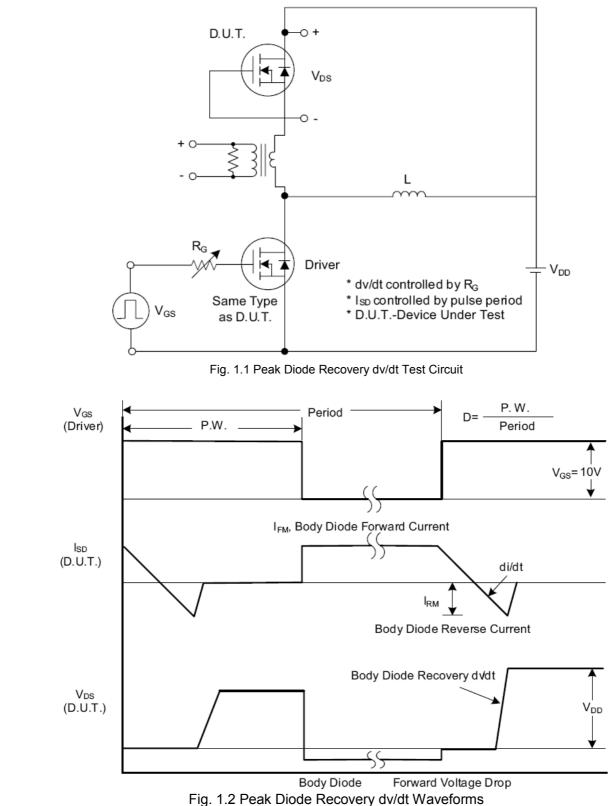


Figure 16.Body Diode Transfer Characteristics



Test Circuits and Waveforms



2

PTA09N45

Test Circuits and Waveforms (Cont.)

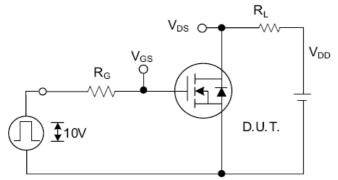


Fig. 2.1 Switching Test Circuit

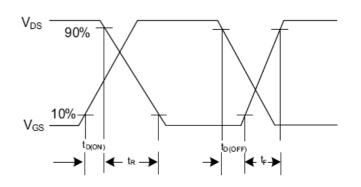


Fig. 2.2 Switching Waveforms

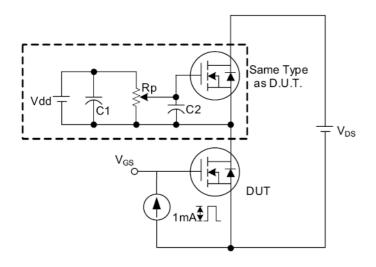


Fig. 3 . 1 Gate Charge Test Circuit

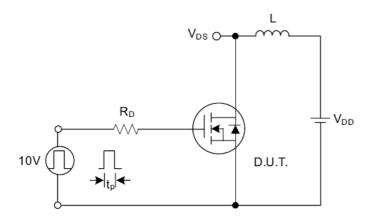


Fig. 4.1 Unclamped Inductive Switching Test Circuit

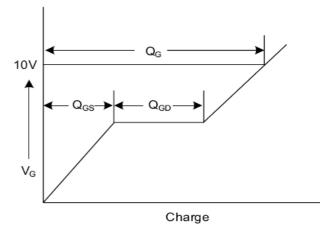
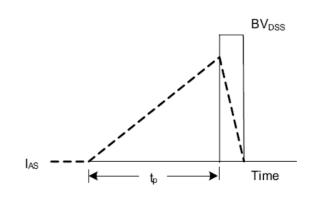
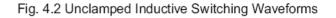


Fig. 3.2 Gate Charge Waveform





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